

**DMN3042L** 

### N-CHANNEL ENHANCEMENT MODE MOSFET

### **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub> max
001/	26.5mΩ @ V <sub>GS</sub> = 10V	5.8A
30V	$32m\Omega$ @ $V_{GS} = 4.5V$	5.0A

### **Features and Benefits**

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

### **Description and Applications**

This MOSFET is designed to minimize the on-state resistance  $(R_{DS(on)})$  and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- Battery charging
- Power management functions
- DC-DC converters
- Portable power adaptors

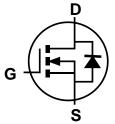
### **Mechanical Data**

- Package: SOT23 (Standard)
- Package Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—Matte Tin Annealed over Copper Lead-Frame.
   Solderable per MIL-STD-202, Method 208 (§3)
- Terminals Connections: See Diagram Below
- Weight: 0.008 grams (Approximate)

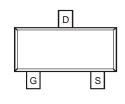
SOT23 (Standard)



Top View



Internal Schematic



Top View

### **Ordering Information**

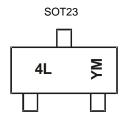
Part Number	Package	Packing		
Fait Nullibei	rackaye	Qty.	Carrier	
DMN3042L-7	SOT23 (Standard)	3,000	Tape & Reel	
DMN3042L-13	SOT23 (Standard)	10,000	Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



# **Marking Information**



 $\begin{array}{l} 4L = Product \ Type \ Marking \ Code \\ YM = Date \ Code \ Marking \\ Y \ or \ \overline{Y} = Year \ (ex: \ I = 2021) \\ M \ or \ \overline{M} = Month \ (ex: \ 9 = September) \end{array}$ 

Date Code Key

Year	2017		2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	Е		- 1	J	K	L	М	N	0	Р	R	S
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec

## Maximum Ratings (@ T<sub>A</sub> = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	$V_{DSS}$	30	V		
Gate-Source Voltage	$V_{GSS}$	±12	V		
Continuous Drain Current (Note 6) V <sub>GS</sub> = 10V	ΙD	5.8 4.0	А		
Maximum Body Diode Forward Current (Note 6)	Is	1.5	Α		
Pulsed Drain Current (10µs pulse, duty cycle = 1%)			I <sub>DM</sub>	30	Α

# **Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Power Dissipation (Note 5)		$P_{D}$	0.72	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R <sub>0JA</sub>	171	°C/W
Power Dissipation (Note 6)		P <sub>D</sub>	1.4	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R <sub>0JA</sub>	93	°C/W
Operating and Storage Temperature Range		T <sub>J.</sub> T <sub>STG</sub>	-55 to +150	°C

DMN3042L Document number: DS37539 Rev. 4 - 2



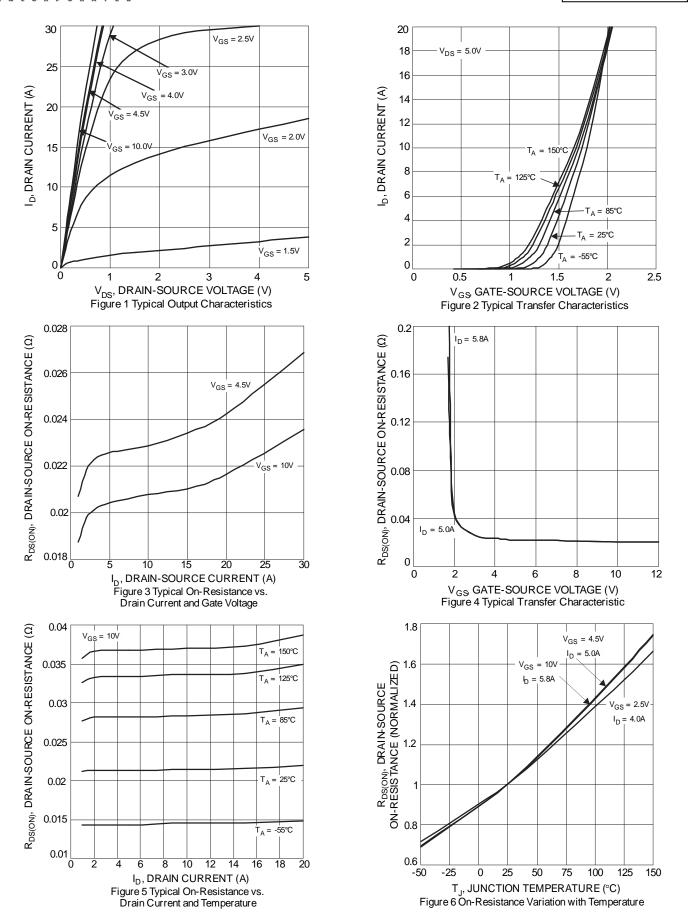
# Electrical Characteristics (@ T<sub>A</sub> = +25°C unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	30	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = 30V, V_{GS} = 0V$
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	$V_{GS(th)}$	0.6		1.4	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
			21	26.5		$V_{GS} = 10V, I_D = 5.8A$
Static Drain-Source On-Resistance	R <sub>DS(on)</sub>		23	32	mΩ	$V_{GS} = 4.5V, I_D = 5.0A$
			29	48		$V_{GS} = 2.5V, I_D = 4.0A$
Diode Forward Voltage	$V_{SD}$	_	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 1A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss		570	860		45)()(
Output Capacitance	Coss	_	63	95	pF	$V_{DS} = 15V, V_{GS} = 0V$ f = 1.0MHz
Reverse Transfer Capacitance	C <sub>rss</sub>		53	80		1 = 1.0IVII 12
Gate Resistance	R <sub>G</sub>	_	3.2	4.5	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge (V <sub>GS</sub> = 10V)	$Q_g$		13.3	20		
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg		6.1	8	nC	V 45V L COA
Gate-Source Charge	$Q_{gs}$	_	1.0	1.5	IIC	$V_{DS} = 15V, I_{D} = 6.9A$
Gate-Drain Charge	$Q_{gd}$	_	1.6	2.5		
Turn-On Delay Time	t <sub>D(on)</sub>	_	1.5	2.4		
Turn-On Rise Time	t <sub>r</sub>	_	3.3	5	nS	$V_{GS} = 10V, V_{DD} = 15V, R_{G} = 3\Omega,$
Turn-Off Delay Time	t <sub>D(off)</sub>	_	13.9	22	no	$I_D = 6.9A$
Turn-Off Fall Time	t <sub>f</sub>		4.9	7		
Body Diode Reverse Recovery Time	t <sub>rr</sub>	_	7.8	12	nS	I <sub>S</sub> = 5A, dI/dt = 100A/µs
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>		1.9	3	nC	I <sub>S</sub> = 5A, dl/dt = 100A/µs

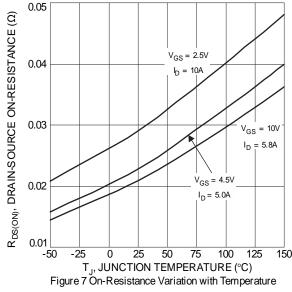
Notes:

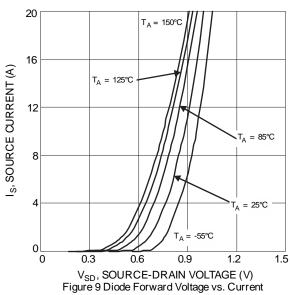
- Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
   Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
   Short duration pulse test used to minimize self-heating effect.
   Guaranteed by design. Not subject to product testing.

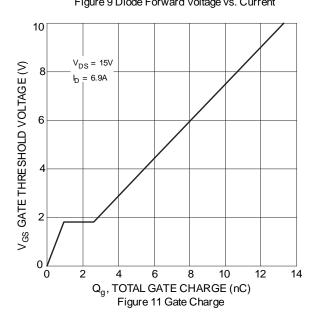


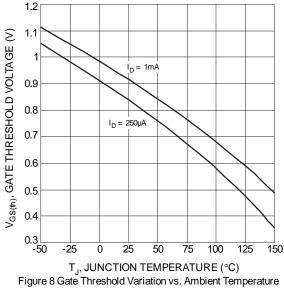


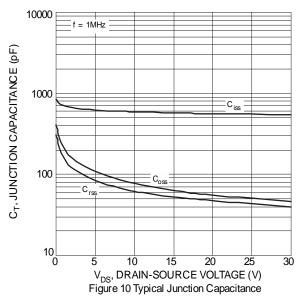


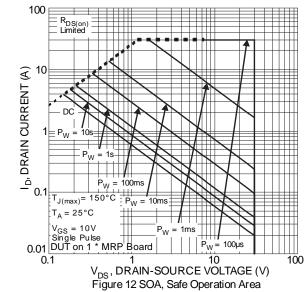




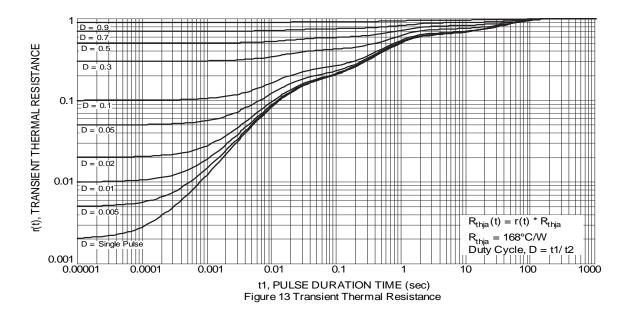














# **Package Outline Dimensions**

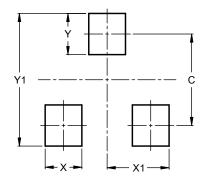
Please see http://www.diodes.com/package-outlines.html for the latest version.

# SOT23 (Standard) GAUGE PLANE 0.25 A A2 L1 B E E1

SOT23 (Standard)							
Dim	Min	Max	Тур				
Α	0.90	1.15	1.025				
A1	0.00	0.10	0.05				
A2	0.85	1.10	0.975				
b	0.30	0.51	0.40				
С	0.080	0.202	0.11				
D	2.80	3.00	2.90				
Е	2.25	2.55	2.40				
E1	1.20	1.40	1.30				
е	0.89	1.03	0.915				
e1	1.78	2.05	1.83				
F	0.40	0.60	0.535				
L1	0.45	0.61	0.55				
L	0.25	0.55	0.40				
а	0°	8°					
All	Dimens	ions in	mm				

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9



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